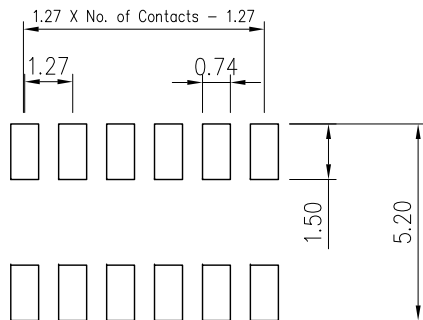


Recommended  
P.C. Board Layout



Contact Plating Type		
Full Gold Plating	Duplex Plating Gold Plated On Contact Area Tin Plated On Solder Area	Full Tin Plating
GF : Gold Flash G1 : Gold 3u" G2 : Gold 5u" G3 : Gold 10u" G4 : Gold 15u"	HF : Gold Flash, Tin 100u" H1 : Gold 3u", Tin 100u" H2 : Gold 5u", Tin 100u" H3 : Gold 10u", Tin 100u" H4 : Gold 15u", Tin 100u"	T1 : Tin 100u"

Specifications

Current Rating : 1 Amps  
 Insulator Resistance : 1000 Megohms min.  
 Contact Resistance : 20 m ohms max.  
 Dielectric Withstanding : AC 600V  
 Operating Temperature : -40°C ~ +105°C  
 Max. Processing Max. : 230°C for 30~60 Seconds  
 (260°C for 10 Seconds)  
 Contact Material : Phosphor Bronze  
 Insulator Material : Polyester, UL 94V-0  
 Standard :  
 Contact Plated : Full Gold, Full Tin, Selective Plated

Order Information

Serial No. SC6 3 - 0 2 XX - 0 XX X  
 Terminal Type 3 : SMT Type  
 Body Option 0 : Leave Blank  
 Row Type 2 : Dual Rows  
 No. of Contact per Row  
 Contact Plated  
 Packing List  
 A : In Tube  
 B : W/Cap In Tube  
 C : W/Film In Tube  
 D : W/Cap In Tape & Reel  
 E : W/Film In Tape & Reel

.X±0.10	.X±	單位 : MM	朝富科技股份有限公司 JOIN TEK JOIN TEK CORPORATION CO.,LTD. 名稱 : Female Header P1.27X1.27mm TITLE : Profile : 3.4mm, Dual Rows, SMT Type
.XX±0.05	.XX±	料號 : SC63-X2XX-0XXX	
.XXX±0.03	.XXX±	日期 : 2005/11/22	
本藍圖為朝富科技股份有限公司所有.未經本公司書面許可,嚴禁印製			圖號 : SC63-X2XX
ECN 設變	MODIFICATION 設變內容	DRAWN 修改	APPROVED 核准
審核 : 製圖 : Sam			DWG NO. : SCALE SHEET REV. 1/1 A